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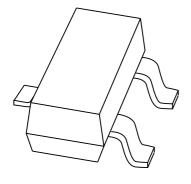
If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS5120T 20 V, 1 A PNP low V_{CEsat} (BISS) transistor

Product data sheet 2003 Sep 29



20 V, 1 A PNP low V_{CEsat} (BISS) transistor

PBSS5120T

FEATURES

- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- · High efficiency leading to less heat generation
- · Reduced printed-circuit board requirements
- Cost effective alternative for MOSFETs in specific applications.

APPLICATIONS

- · Power management
 - DC/DC conversion
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load drivers (e.g. relays, buzzers and motors).

DESCRIPTION

PNP BISS transistor in a SOT23 plastic package providing ultra low $\rm V_{CEsat}$ and $\rm R_{CEsat}$ parameters.

NPN complement: PBSS4120T.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS5120T	*3K

Note

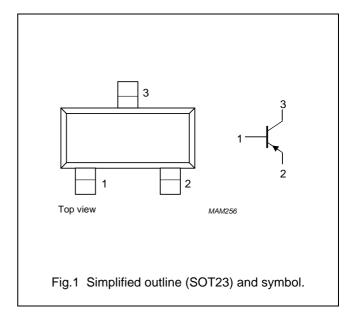
- 1. * = p: made in Hong Kong.
 - * = t: made in Malaysia.
 - * = W: made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-20	V
I _C	collector current (DC)	-1	Α
I _{CM}	peak collector current	-2	Α
R _{CEsat}	equivalent on-resistance	250	mΩ

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



ORDERING INFORMATION

TYPE NUMBER	PACKAGE NAME DESCRIPTION VERSION		
TIPE NOWIBER			
PBSS5120T	_	plastic surface mounted package; 3 leads	SOT23

20 V, 1 A PNP low V_{CEsat} (BISS) transistor

PBSS5120T

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	-20	V
V _{CEO}	collector-emitter voltage	open base	_	-20	٧
V _{EBO}	emitter-base voltage	open collector	_	- 5	V
I _C	collector current (DC)		_	-1	Α
I _{CM}	peak collector current		-	-2	Α
I _{BM}	peak base current		_	-200	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	-	300	mW
		T _{amb} ≤ 25 °C; note 2	-	480	mW
T _{stg}	storage temperature		-65	+150	°C
T _j	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air; note 1	417	K/W
		in free air; note 2	260	K/W

Notes

- 1. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, standard footprint.
- 2. Device mounted on a FR4 printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -20 \text{ V}; I_E = 0$	_	_	-100	nA
		$V_{CB} = -20 \text{ V}; I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; I_C = 0$	_	_	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	300	450	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	250	350	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}$	200	290	_	
V _{CEsat}	collector-emitter saturation	$I_C = -100 \text{ mA}; I_B = -1 \text{ mA}$	_	_	-100	mV
	voltage	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-125	mV
		$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-250	mV
R _{CEsat}	equivalent on-resistance	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}; \text{ note 1}$	_	_	250	mΩ
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	_	_	-0.75	V
f _T	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -10 \text{ V};$ f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	=	=	28	pF

Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

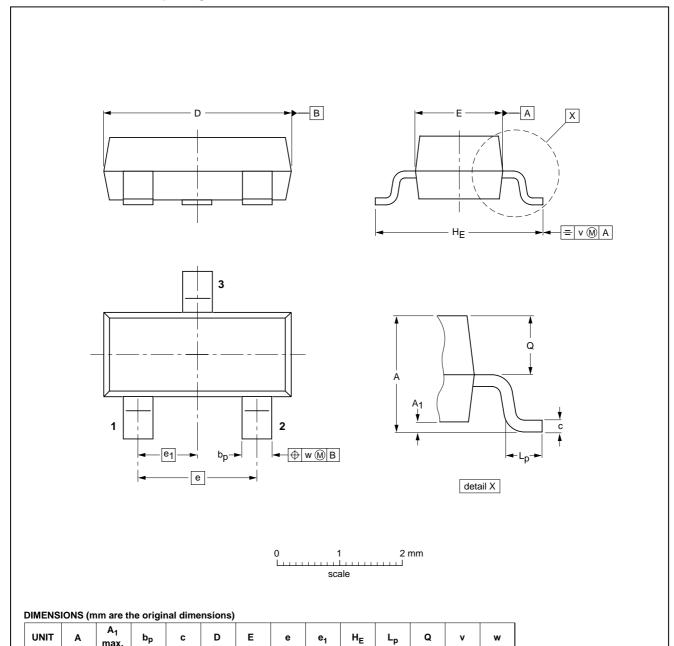
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PBSS5120T

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT23



OUTLINE	INE REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT23		TO-236AB				-97-02-28 99-09-13

0.95

0.45

0.15

0.55

0.45

0.1

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0.48

0.38

0.1

mm

0.15

0.09

3.0

2.8

1.4

1.9

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PBSS5120T

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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NXP Semiconductors

Customer notification

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Contact information

For additional information please visit: http://www.nxp.com

For sales offices addresses send e-mail to: salesaddresses@nxp.com

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Printed in The Netherlands R75/01/pp7 Date of release: 2003 Sep 29 Document order number: 9397 750 11899



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